

SuperFET**

FCP20N60 / FCPF20N60 600V N-Channel MOSFET

Features

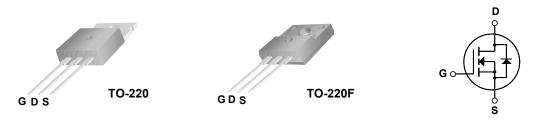
- 650V @T_J = 150°C
- Typ. $R_{DS(on)} = 0.15\Omega$
- Ultra low gate charge (typ. Q_g = 75nC)
- Low effective output capacitance (typ. Coss.eff = 165pF)
- 100% avalanche tested
- · RoHS Compliant



Description

SuperFETTM is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



Absolute Maximum Ratings

Symbol	Parameter		FCP20N60 FCPF20N60		Unit	
V _{DSS}	Drain-Source Voltage		600		V	
I _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		20 12.5	20* 12.5*	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	60	60*	Α
V _{GSS}	Gate-Source voltage		± 30		V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2		(Note 2)	690		mJ
I _{AR}	Avalanche Current		(Note 1)	20		Α
E _{AR}	Repetitive Avalanche Energy (Note		(Note 1)	20.8		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns	
P _D	Power Dissipation	(T _C = 25°C) - Derate above 25°C		208 1.67	39 0.3	W W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C	
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300		°C	

^{*}Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCP20N60	FCPF20N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.6	3.2	°C/W
R _{0JA} Thermal Resistance, Junction-to-Ambient		62.5	62.5	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP20N60	FCP20N60	TO-220	-	-	50
FCPF20N60	FCPF20N60	TO-220F	-	-	50

Electrical Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Off Charac	teristics			·		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V$, $I_D = 250\mu A$, $T_J = 25^{\circ}C$	600			V
		V _{GS} = 0V, I _D = 250μA, T _J = 150°C	-	650		V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C		0.6		V/°C
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	V _{GS} = 0V, I _D = 20A		700		V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600V, V _{GS} = 0V V _{DS} = 480V, T _C = 125°C			1 10	μA μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V	-		-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 10A		0.15	0.19	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40V, I _D = 10A (Note 4)		17		S
Dynamic C	haracteristics					
C _{iss}	Input Capacitance	20 . 00 .		2370	3080	pF
C _{oss}	Output Capacitance	f = 1.0MHz	-	1280	1665	pF
C _{rss}	Reverse Transfer Capacitance			95		pF
C _{oss}	Output Capacitance	V _{DS} = 480V, V _{GS} = 0V, f = 1.0MHz		65	85	pF
Coss eff.	Effective Output Capacitance	V_{DS} = 0V to 400V, V_{GS} = 0V	-	165		pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300V, I _D = 20A		62	135	ns
t _r	Turn-On Rise Time	$R_G = 25\Omega$		140	290	ns
t _{d(off)}	Turn-Off Delay Time		-	230	470	ns
t _f	Turn-Off Fall Time	(Note 4, 5)	-	65	140	ns
Qg	Total Gate Charge	V _{DS} = 480V, I _D = 20A		75	98	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10V		13.5	18	nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)	-	36		nC
Drain-Sour	ce Diode Characteristics and Maximur	n Ratings				
I _S Maximum Continuous Drain-Source Diode Forward Current					20	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				60	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 20A	-	530		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s (Note 4)$		10.5		μС

Notes

^{1.} Repetitive Rating: Pulse width limited by maximum junction temperature

^{2.} I_{AS} = 10A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

^{3.} I $_{SD}$ \leq 20A, di/dt \leq 200A/ μ s, V $_{DD}$ \leq BV $_{DSS}$, Starting T $_{J}$ = 25°C

^{4.} Pulse Test: Pulse width $\leq 300 \mu s, \ \text{Duty Cycle} \leq 2\%$

^{5.} Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

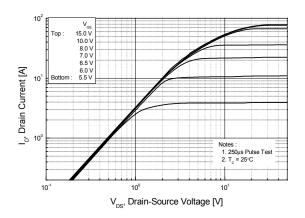


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

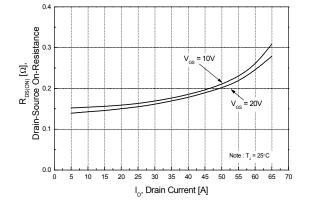


Figure 2. Transfer Characteristics

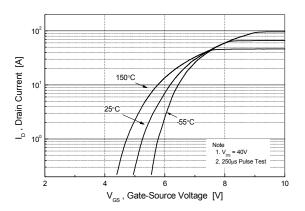


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

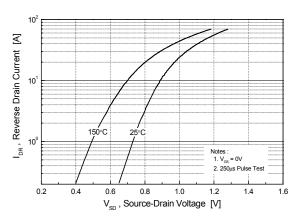


Figure 5. Capacitance Characteristics

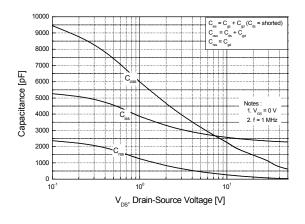
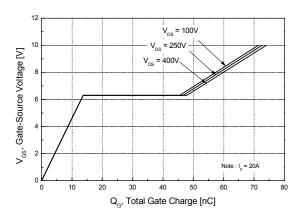


Figure 6. Gate Charge Characteristics



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Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

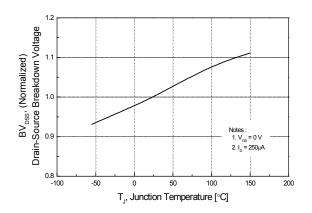


Figure 8. On-Resistance Variation vs. Temperature

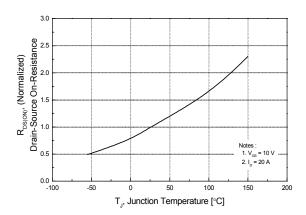


Figure 9-1. Maximum Safe Operating Area for FCP20N60

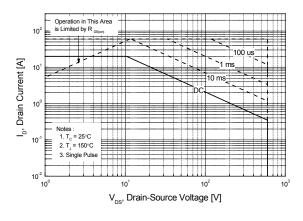


Figure 9-2. Maximum Safe Operating Area for FCPF20N60

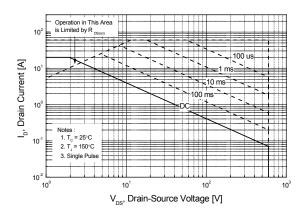
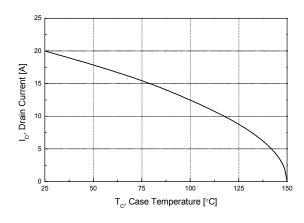


Figure 10. Maximum Drain Current vs. Case Temperature



Typical Performance Characteristics (Continued)

Figure 11-1. Transient Thermal Response Curve for FCP20N60

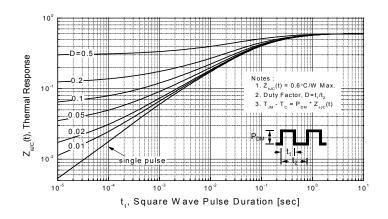
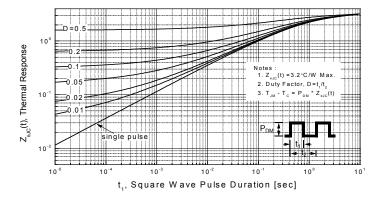
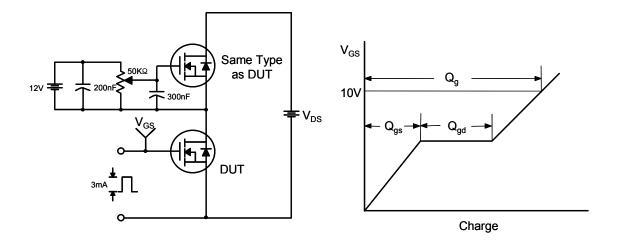


Figure 11-2. Transient Thermal Response Curve for FCPF20N60

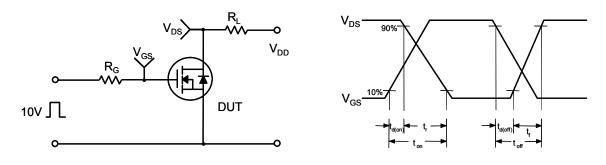


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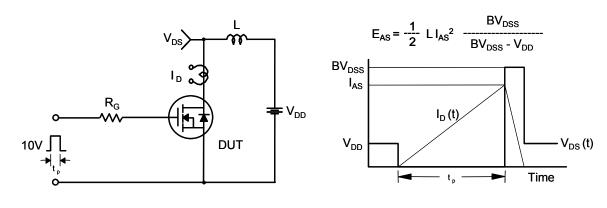
Gate Charge Test Circuit & Waveform



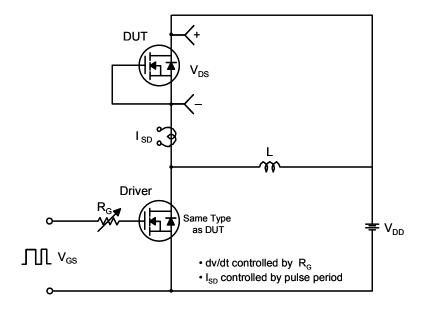
Resistive Switching Test Circuit & Waveforms

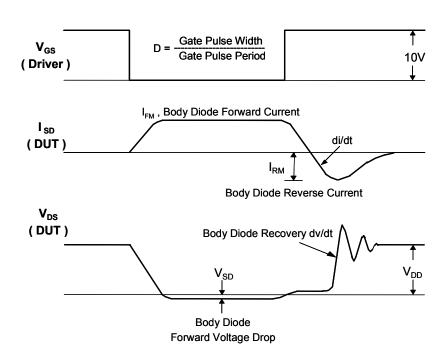


Unclamped Inductive Switching Test Circuit & Waveforms



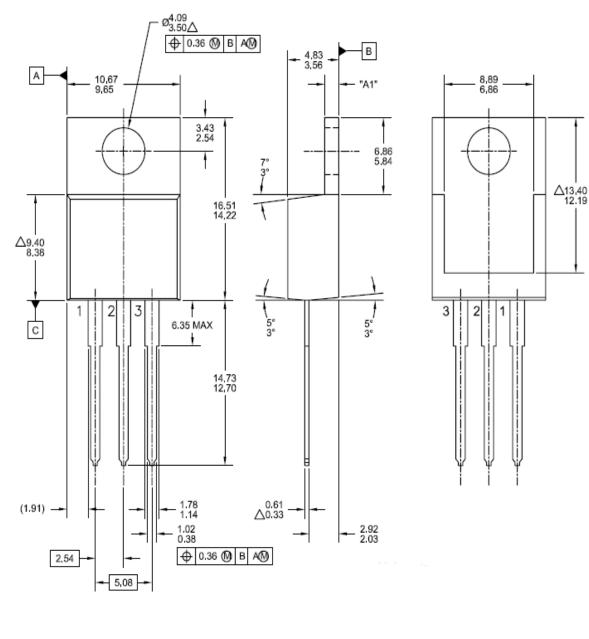
Peak Diode Recovery dv/dt Test Circuit & Waveforms

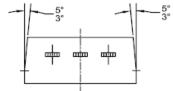




Mechanical Dimensions

TO - 220





Dimensions in Millimeters

Mechanical Dimensions (Continued) TO-220F 3.30 ± 0.10 2.54 ± 0.20 10.16 ± 0.20 $\emptyset 3.18 \pm 0.10$ (7.00)(0.70) 6.68 ± 0.20 Ф 15.87 ± 0.20 15.80 ± 0.20 (1.00x45°) MAX1.47 9.75 ± 0.30 0.80 ± 0.10 0.35 ± 0.10 $0.50^{\,+0.10}_{\,-0.05}$ 2.76 ± 0.20 2.54TYP 2.54TYP [2.54 ±0.20] [2.54 ±0.20] 4.70 ±0.20 9.40 ± 0.20 Dimensions in Millimeters





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